

• Power switching circuits



ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) Tc=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	60	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	360	A
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

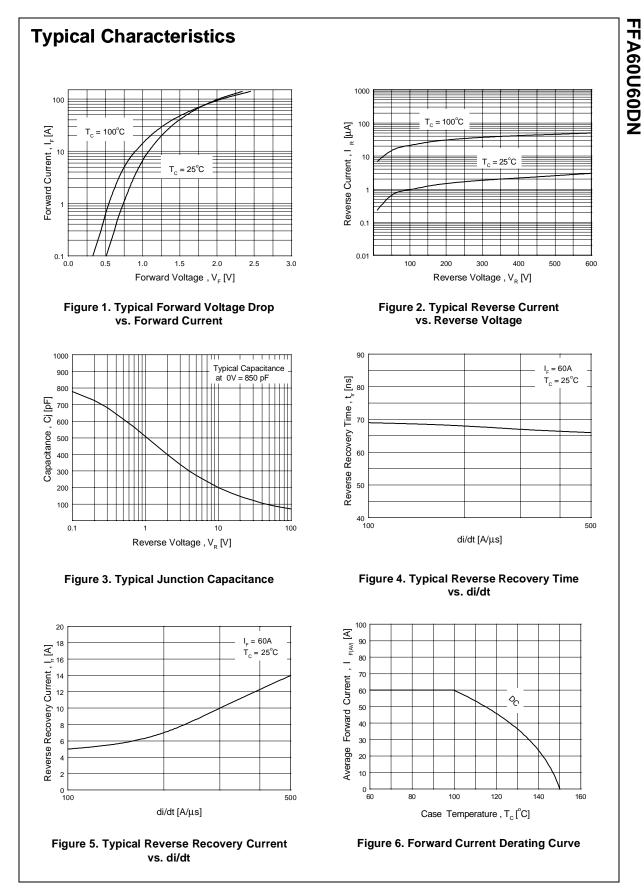
Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	0.45	°C/W

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

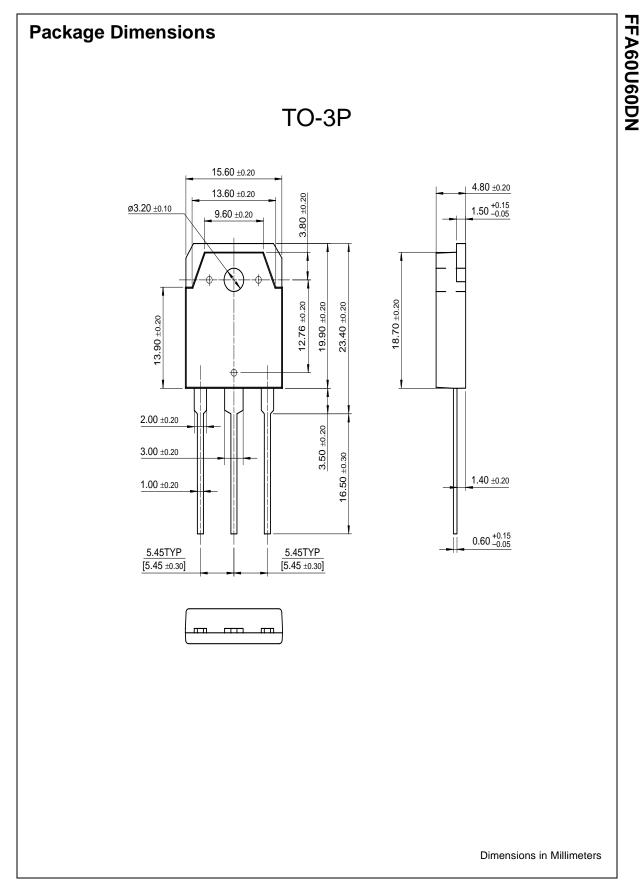
Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage				1	V
	I _F = 60A	T _C = 25 °C	-	-	2.2	
	I _F = 60A	T _C = 25 °C T _C = 100 °C	-	-	2.0	
I _{RM} *	Maximum Instantaneous Reverse Current					μA
	@ rated V _R	T _C = 25 °C	-	-	25	
		T _C = 25 °C T _C = 100 °C	-	-	250	
t _{rr}	Maximum Reverse Recovery Time		-	-	90	ns
I _{rr}	Maximum Reverse Recovery Current		-	-	9	А
Q _{rr}	Maximum Reverse Recovery Charge (I _F =60A, di/dt = 200A/μs)		-	-	405	nC
W _{AVL}	Avalanche Energy		1.0	-	-	mJ

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